IPC ASSOCIATION ELECTRONIC	Material Com © Copyright 2005. international and P	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				*	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information			
uppliei	r Information														
Company name* Company				any unique ID			Unique ID Authority					Response Date*			
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ontact N	lame	Title - Contact			I	Phone - Contact*				Email - Contact*					
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uthorize	ed Representative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
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	Requester Item Number	Mfr Item	Mfr Item Number Mfr Item		tem Name		Effective Date	e Version Manufacturing Site		ring Site	,	Weight*	UOM	Unit Type	
		BC327BU PNP -45V/-0.8			100-630		2024-05-06 CNF				2	223.092	mg	Each	
(anufa	cturing Process Inform		Terminal Base	Alloy	-STD-020 MS	I. Poting	Dank Proc	Pass Rod	y Tamparat	ura May Ti	ma at Paak '	Tamparat	ura Numbe	er of Paflow Cyc	plac
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omments	. ,		Alloy	1	11.2		Į v					Secon	uo   J		
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or more	information regarding materia	al composition	nlease refer t	o nage 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided in form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.075 mg		Supplier	Silicon (Si)	7440-21-3		0.075	mg
Lead Frame	101.001		Supplier	Silver (Ag)	7440-22-4		1.01	mg
			Supplier	Manganese (Mn)	7439-96-5		0.505	mg
			В	Nickel (Ni)	7440-02-0		0.182	mg
			Supplier	Iron (Fe)	7439-89-6		98.4	mg
			Supplier	Copper (Cu)	7440-50-8		0.904	mg
Mold Compound-Black	112.0		Supplier	2,6-dibromo-4-[1-(3-bromo-4-hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		3.36	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		22.4	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		2.8	mg
			Supplier	Carbon Black (C)	1333-86-4		0.84	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		82.6	mg
Plating	9.94	mg	Supplier	Tin (Sn)	7440-31-5		9.94	mg
Wire Bond - Au	0.076	mg	Supplier	Gold (Au)	7440-57-5		0.076	mg